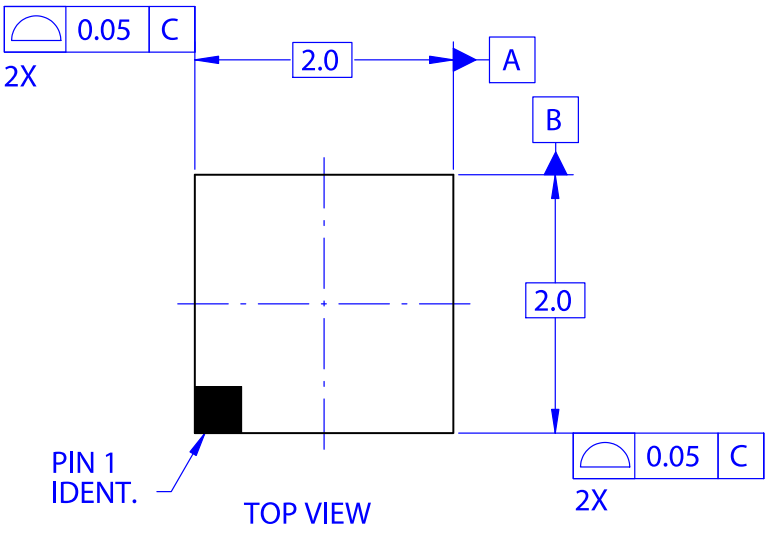
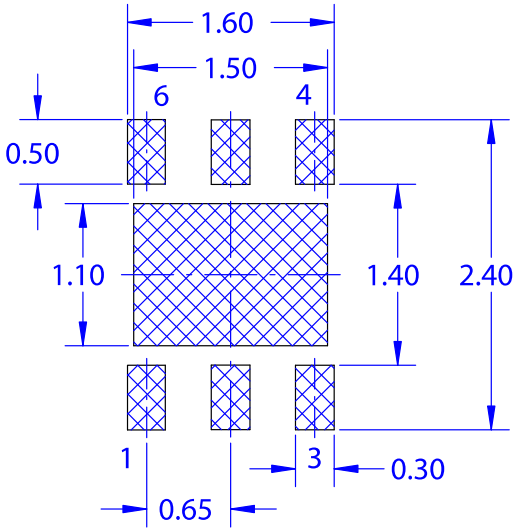
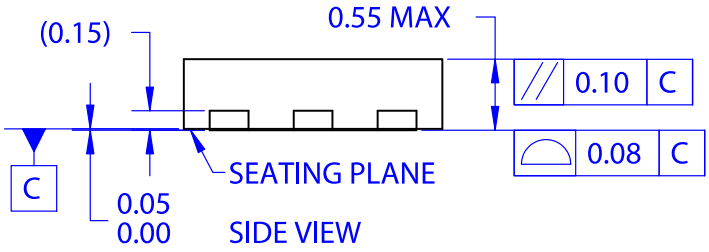
UDFN6 2x2, 0.65P
CASE 517DR
ISSUE O

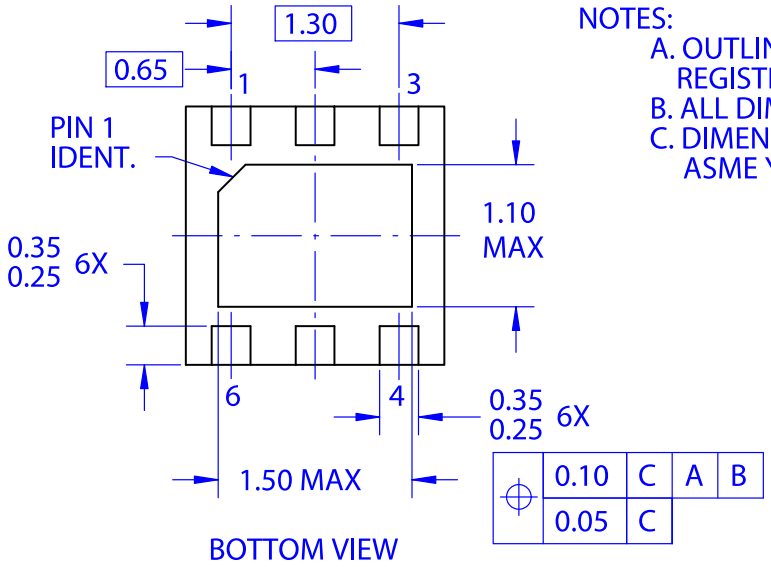
DATE 31 OCT 2016





LAND PATTERN RECOMMENDATION





NOTES:
A. OUTLINE BASED ON JEDEC REGISTRATION MO-229, VARIATION VCCC
B. ALL DIMENSIONS ARE IN MILLIMETERS
C. DIMENSIONS AND TOLERANCES PER ASME Y14.5, 2009

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